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Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	40				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.00163				
I _D (A)	150				
Configuration	Single				
Package	TO-263				

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_q and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



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G C	
N-Channel MOSFET	
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ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	Drain-source voltage			V		
Gate-source voltage	V_{GS}	± 20	V			
Continuous drain current	T _C = 25 °C ^a	- I _D	150			
Continuous drain current	T _C = 125 °C		125			
Continuous source current (diode conduction)	I _S	136	Α			
Pulsed drain current ^b	I _{DM}	300				
Single pulse avalanche current	Single pulse avalanche current		60			
Single pulse avalanche energy		E _{AS}	180	mJ		
Maximum power dissipation ^b	T _C = 25 °C	D	150	W		
iviaxiiiiuiii powei dissipatioii ~	T _C = 125 °C	P_{D}	50	VV		
Operating junction and storage temperature ra	ange	T _J , T _{stg}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	LIMIT	UNIT			
Junction-to-ambient F	PCB mount c	R_{thJA}	40	°C/W		
Junction-to-case (drain)		R _{thJC}	1			

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	2.5	3.0	3.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 40 V	=	-	1	
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 40 V, T _J = 125 °C	=	-	50	μA
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	-	-	300	μΑ
On-state drain current a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	100	-	-	Α
		V _{GS} = 10 V	I _D = 35 A	-	0.00133	0.00163	
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 10 V	I _D = 35 A, T _J = 125 °C	-	-	0.00268	Ω
		V _{GS} = 10 V	I _D = 35 A, T _J = 175 °C	-	-	0.00326	
Forward transconductance b	9 _{fs}	V_{DS}	= 15 V, I _D = 35 A	-	143	-	S
Dynamic ^b					•	•	
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	6783	9200	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	1771	2400	
Reverse transfer capacitance	C _{rss}				109	150	
Total gate charge ^c	Qg	$V_{GS} = 10 \text{ V}$ $V_{DS} = 20 \text{ V}, I_D = 100 \text{ A}$		-	106	160	
Gate-source charge c	Q_{gs}			-	33	-	nC
Gate-drain charge ^c	Q _{gd}			-	21	-	
Gate resistance	Rg	f = 1 MHz		1.25	2.75	4.35	Ω
Turn-on delay time ^c	t _{d(on)}			-	19	30	
Rise time ^c	t _r	V_{DD} = 20 V, R_L = 0.2 Ω $I_D \cong 100$ A, V_{GEN} = 10 V, R_g = 1 Ω		-	194	300	
Turn-off delay time ^c	t _{d(off)}			-	45	70	ns
Fall time ^c	t _f			-	26	40	
Source-Drain Diode Ratings and Chara-	cteristics ^b				•	•	
Pulsed current ^a	I _{SM}			-	-	300	Α
Forward voltage	V_{SD}	I _F = 60 A, V _{GS} = 0 V		-	0.83	1.5	V
Body diode reverse recovery time	t _{rr}	I _F = 30 A, di/dt = 100 A/μs		-	88	180	ns
Body diode reverse recovery charge	Q _{rr}			-	186	380	nC
Reverse recovery fall time	ta			-	57	-	
Reverse recovery rise time	t _b			-	31	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-4.6	-	Α

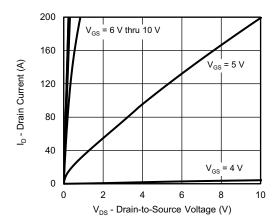
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

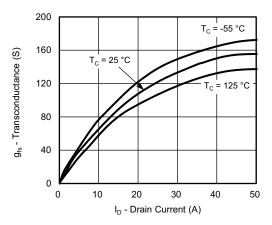
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



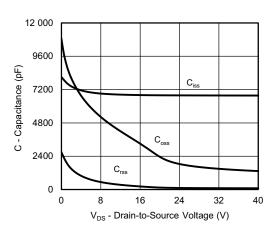
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Output Characteristics



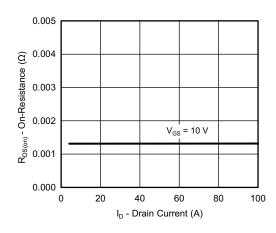
Transconductance



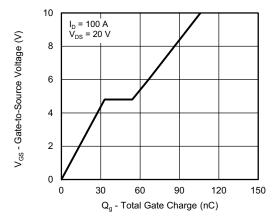
Capacitance

125 100 I_D - Drain Current (A) 75 T_C = 25.°C 50 25 T_C = 125 °C .55 °C 0 0 2 4 8 10 V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



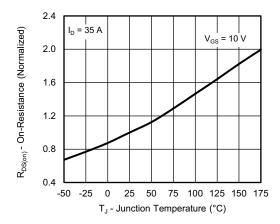
On-Resistance vs. Drain Current



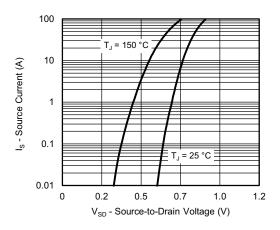
Gate Charge



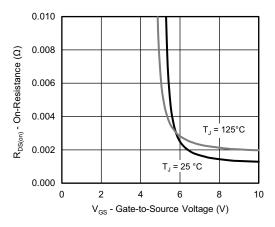
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



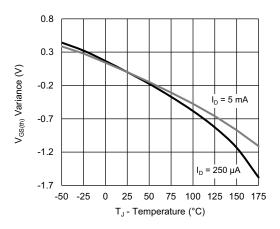
On-Resistance vs. Junction Temperature



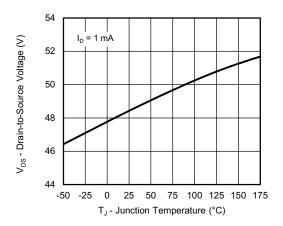
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



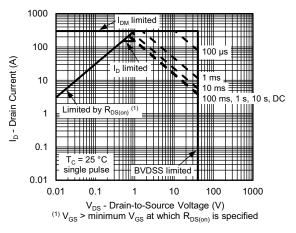
Threshold Voltage



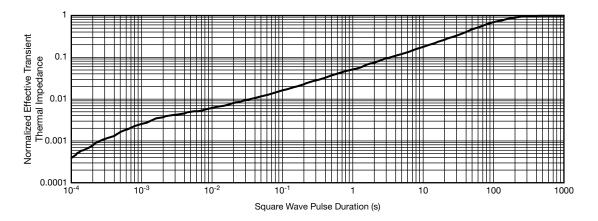
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



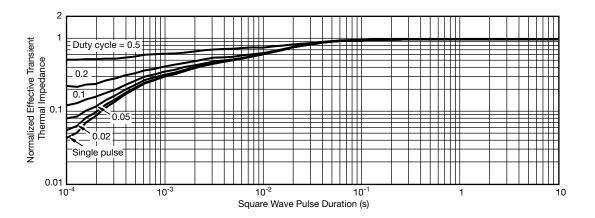
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

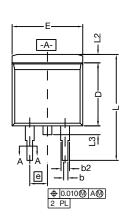
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

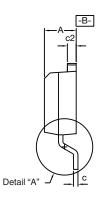
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

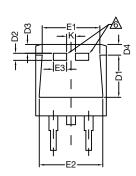
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TO-263 (D²PAK): 3-LEAD

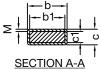








DETAIL A (ROTATED 90°)



<u> </u>	b	
2 T	ਹ <i>ੀ </i>	
	SECTION A-4	1

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

	INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.
Α		0.160	0.190	4.064	4.826
	b	0.020	0.039	0.508	0.990
	b1	0.020	0.035	0.508	0.889
	b2	0.045	0.055	1.143	1.397
c*	Thin lead	0.013	0.018	0.330	0.457
C	Thick lead	0.023	0.028	0.584	0.711
c1	Thin lead	0.013	0.017	0.330	0.431
CI	Thick lead	0.023	0.027	0.584	0.685
	c2	0.045	0.055	1.143	1.397
	D	0.340	0.380	8.636	9.652
	D1	0.220	0.240	5.588	6.096
	D2	0.038	0.042	0.965	1.067
	D3	0.045	0.055	1.143	1.397
	D4	0.044	0.052	1.118	1.321
	Е	0.380	0.410	9.652	10.414
	E1	0.245	-	6.223	=
	E2	0.355	0.375	9.017	9.525
	E3	0.072	0.078	1.829	1.981
	е	0.100) BSC	2.54 BSC	
	K	0.045	0.055	1.143	1.397
L		0.575	0.625	14.605	15.875
L1		0.090	0.110	2.286	2.794
L2		0.040	0.055	1.016	1.397
	L3	0.050	0.070	1.270	1.778
	L4	0.010 BSC		0.254 BSC	
	М	-	0.002	-	0.050
ECN: T13-0707-Rev. K, 30-Sep-13					

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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